

## N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTORS

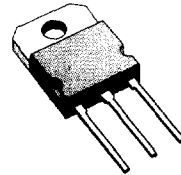
TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
SGSP461	100 V	0.15 Ω	20 A
SGSP462	80 V	0.1 Ω	25 A

- HIGH SPEED SWITCHING APPLICATIONS
- 80 - 100 VOLTS - FOR UPS APPLICATIONS
- RATED FOR UNCLAMPED INDUCTIVE SWITCHING (ENERGY TEST) ♦
- ULTRA FAST SWITCHING
- EASY DRIVE FOR REDUCED COST AND SIZE

### INDUSTRIAL APPLICATIONS:

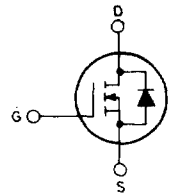
- UNINTERRUPTIBLE POWER SUPPLIES
- MOTOR CONTROLS

N - channel enhancement mode POWER MOS field effect transistors. Easy drive and very fast switching times make these POWER MOS transistors ideal for high speed switching applications. Typical applications include UPS, battery chargers, printer hammer drivers, solenoid drivers and motor control.



TO-218

### INTERNAL SCHEMATIC DIAGRAM



### ABSOLUTE MAXIMUM RATINGS

	SGSP461	SGSP462	
V <sub>DS</sub>	100	80	V
V <sub>DGR</sub>	100	80	V
V <sub>GS</sub>		±20	V
I <sub>D</sub>	20	25	A
I <sub>D</sub>	13	16	A
I <sub>DM</sub> (*)	80	100	A
P <sub>tot</sub>		125	W
		1	W/°C
T <sub>stg</sub>	-65 to 150		°C
T <sub>j</sub>	150		°C

(\*) Pulse width limited by safe operating area

♦ Introduced in 1988 week 44

**THERMAL DATA**

$R_{thj - case}$	Thermal resistance junction-case	max	1	°C/W
$T_L$	Maximum lead temperature for soldering purpose		275	°C

**ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25^{\circ}C$  unless otherwise specified)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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**OFF**

$V_{(BR) DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu A$ for <b>SGSP461</b> for <b>SGSP462</b>	$V_{GS} = 0$	100 80		V V
$I_{DSS}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating} \times 0.8$	$T_c = 125^{\circ}C$		250 1000	$\mu A$ $\mu A$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20 V$			$\pm 100$	nA

**ON (\*)**

$V_{GS (th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$	$I_D = 250 \mu A$	2		4	V
$R_{DS (on)}$	Static drain-source on resistance	$V_{GS} = 10 V$ $I_D = 10 A$ for <b>SGSP461</b> $I_D = 12.5 A$ for <b>SGSP462</b> $V_{GS} = 10 V$ $T_c = 100^{\circ}C$ $I_D = 10 A$ for <b>SGSP461</b> $I_D = 12.5 A$ for <b>SGSP462</b>				0.15 0.1 0.3 0.2	$\Omega$ $\Omega$ $\Omega$ $\Omega$

**ENERGY TEST**

$I_{UIS}$	Unclamped inductive switching current (single pulse)	$V_{DD} = 30 V$ starting $T_j = 25^{\circ}C$ for <b>SGSP461</b> for <b>SGSP462</b>	$L = 100 \mu H$	20 25			A A
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**DYNAMIC**

$g_{fs}$	Forward transconductance	$V_{DS} = 25 V$	$I_D = 12.5 A$	4.5			mho
$C_{iss}$ $C_{oss}$ $C_{rss}$	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 V$ $V_{GS} = 0$	$f = 1 MHz$		950	1200 480 230	pF pF pF

## ELECTRICAL CHARACTERISTICS (Continued)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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## SWITCHING

$t_{d(on)}$	Turn-on time	$V_{DD} = 50\text{ V}$ $V_i = 10\text{ V}$ (see test circuit)	$I_D = 12.5\text{ A}$ $R_f = 4.7\ \Omega$		20	30	ns
$t_r$	Rise time				60	80	ns
$t_{d(off)}$	Turn-off delay time				65	85	ns
$t_f$	Fall time				25	35	ns

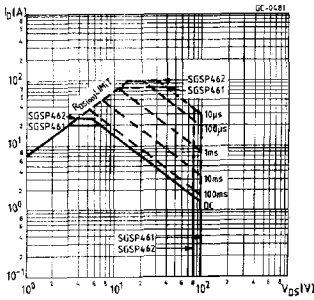
## SOURCE DRAIN DIODE

$I_{SD}$	Source-drain current	for <b>SGSP461</b> for <b>SGSP462</b> for <b>SGSP461</b> for <b>SGSP462</b>			20	A
$I_{SDM} (*)$	Source-drain current (pulsed)				25	A
					80	A
					100	A
$V_{SD}$	Forward on voltage	$V_{GS} = 0$ $I_{SD} = 20\text{ A}$ for <b>SGSP461</b> $I_{SD} = 25\text{ A}$ for <b>SGSP462</b>			1.35	V
					1.35	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 25\text{ A}$ $di/dt = 25\text{ A}/\mu\text{s}$	$V_{GS} = 0$		190	ns

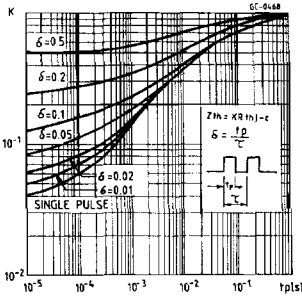
(\*) Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

(\*) Pulse width limited by safe operating area

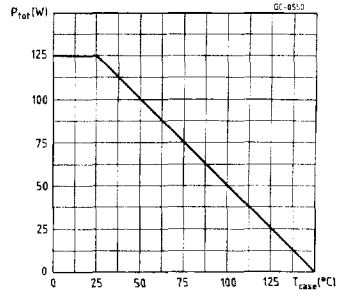
Safe operating areas



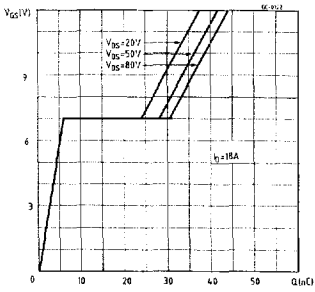
Thermal impedance



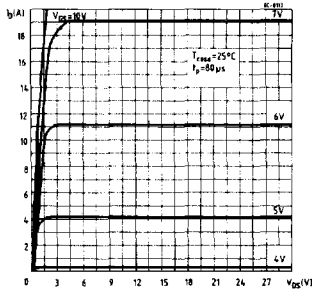
Derating curve



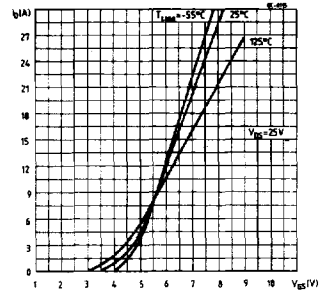
Output characteristics



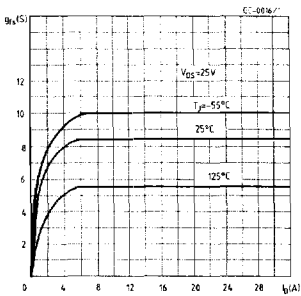
Output characteristics



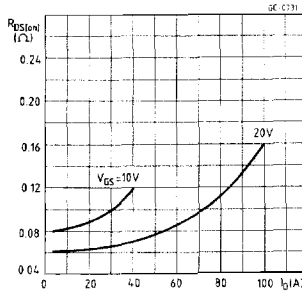
Transfer characteristics



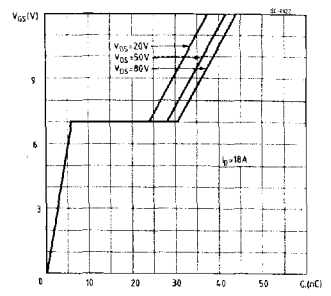
Transconductance



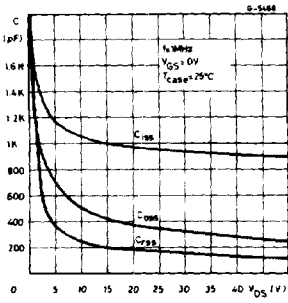
Static drain-source on resistance



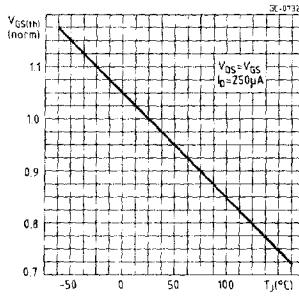
Gate charge vs gate-source voltage



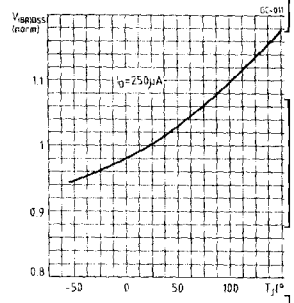
Capacitance variation



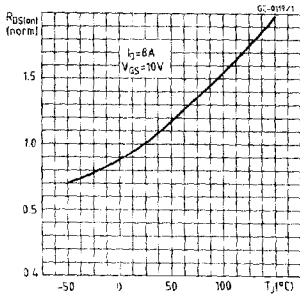
Normalized gate threshold voltage vs temperature



Normalized breakdown voltage vs temperature



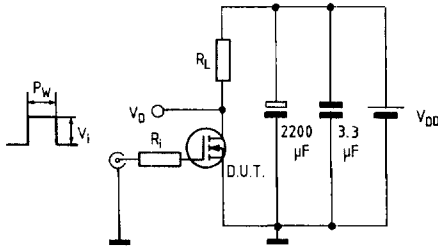
Normalized on resistance vs temperature



Source-drain diode forward characteristics



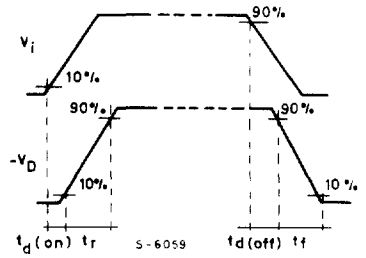
Switching times test circuit for resistive load



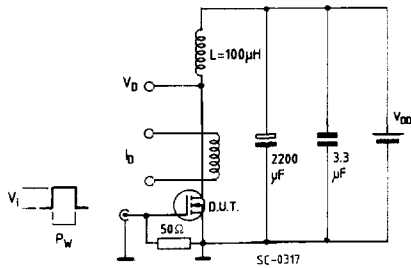
Pulse width  $\leq 100 \mu s$   
Duty cycle  $\leq 2\%$

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Switching time waveforms for resistive load



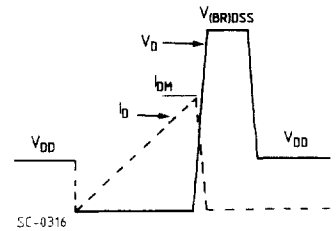
Unclamped inductive load test circuit



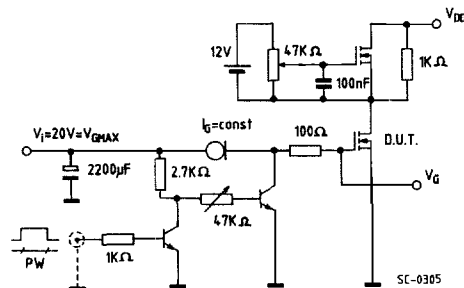
$V_i = 12 V$  - Pulse width: adjusted to obtain specified  $I_{DM}$

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Unclamped inductive waveforms



Gate charge test circuit



PW adjusted to obtain required  $V_G$

SC-0305

Body-drain diode  $t_{rr}$  measurement  
Jedec test circuit

